

APPROVAL SHEET

WLPM131350 Series SMD Molded Power Inductors





*Contents in this sheet are subject to change without prior notice.

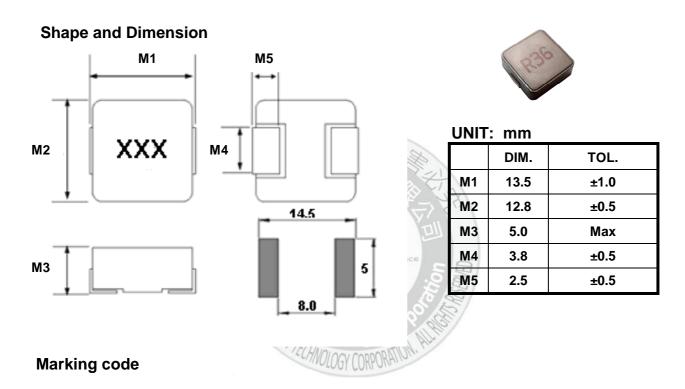


Features

- 1. Shielded construction.
- 2. Ultra low buzz noise.
- 3. Low DCR.
- 4. Handles high transient current spikes without saturation.
- 5. Encapsulated body offers improved environmental protection and moisture resistance.
- 6. Higher dielectric with standing voltage.
- 7. Corrosion resistant package.
- 8. RoHS Compliance.

Applications

- 1. PDA/Notebook/Desktop/Server applications high current and low profile power supplier.
- 2. High current POL converters.
- 3. Battery powered devices.



Marking ex:1.0uH →1R0





Ordering Information

| WL | PM | 1313 | 50 | M | R33 | L | С |
|-----------------|-------------------------------------|--------------|-----------|-----------|--------------------------|---------------------------------|-----------|
| Product Code | Series | Dimensions | Thickness | Tolerance | Value | Packing Code | |
| WL: Inductor | SMD molded power inductor. | 13.5 *12.8mm | 5.0mm | M: ± 20% | R33=0.33uH 2R2=2.20uH | L=13" Reeled (Embossed tape) | C:General |

Electrical Characteristics

WLPM131350*LC series

| PART NO. | Inductance | Tolerance | DCR Max | imum (mΩ) | Rated Current | l sat | |
|------------------|------------|------------------|---------|-----------|------------------|-------------|--|
| | (uH) | | TYP | MAX | Typical (A) | Typical (A) | |
| WLPM131350MR10LC | 0.1 | M | 0.53 | 0.6 | 55 | 118 | |
| WLPM131350MR22LC | 0.22 | M | 0.64 | 0.8 | 51 | 110 | |
| WLPM131350MR33LC | 0.33 | M | 0.85 | 1.1 | 42 | 80 | |
| WLPM131350MR47LC | 0.47 | M | 1.1 | 1.3 | 38 | 65 | |
| WLPM131350MR56LC | 0.56 | EFTM | 1.3 | 1.5 | 36 | 55 | |
| WLPM131350MR68LC | 0.68 | 《长M设份 | 1.5 | 1.7 | 34 | 54 | |
| WLPM131350MR82LC | 0.82 | M | 2 | 2.3 | 31 | 53 | |
| WLPM131350M1R0LC | 1 7 11 | M | 2.1 | 2.5 | 29 | 50 | |
| WLPM131350M1R2LC | 1.2 | MS | 2.8 | 3.5 | 25 | 49 | |
| WLPM131350M1R5LC | 1.5 | PASSIVE MYSTEM A | 3.4 S | 4.1 | 23 | 48 | |
| WLPM131350M1R8LC | 1.8 | M | 4.2 | 4.9 | 19 | 40 | |
| WLPM131350M2R2LC | 2.2 | M | 4.6 | 5.5 | 20 | 32 | |
| WLPM131350M3R3LC | 3.3 | Ch Mology | 7.7 | 9.2 | 15 | 32 | |
| WLPM131350M4R7LC | 4.7 | ECHNO/MEN CORDO | 12.8 | 15 | 12 | 27 | |
| WLPM131350M5R6LC | 5.6 | M | 14 | 16.5 | 11.5 | 22 | |
| WLPM131350M6R8LC | 6.8 | M | 15.4 | 18.5 | 11 | 21 | |
| WLPM131350M7R8LC | 7.8 | М | 17.2 | 20.5 | 10 | 18 | |
| WLPM131350M8R2LC | 8.2 | М | 18.9 | 22.5 | 9.5 | 18 | |
| WLPM131350M100LC | 10 | М | 21.4 | 25.5 | 9 | 16 | |

TEST INSTRUMENT: CHROMA 16502 \ Zentech1320+Zentech3305

- (1). Test Freq: 100KHz, 1.0V
- (2). All test data is referenced to 25°C ambient.
- (3). Operating Temperature Range -55°C to +125°C.
- (4). Rated Current: DC current(A)that will cause an approximate \triangle T of 40 $^{\circ}$ C.
- (5). I sat: DC current(A)that will cause Lo to drop approximately 30%.
- (6). The part temperature(ambient +temp rise)should not exceed

125 ℃ under worst case operating conditions. Circuit design, component placement, PWB trace size and thickness, airflow and other cooling provisions all affect the part temperature Part temperature should be verified



Reliability Performance

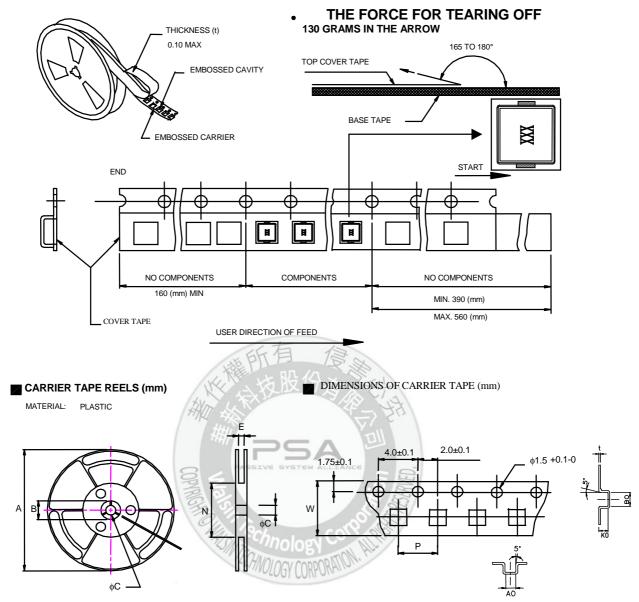
| Test Item | Test Condition | Standard Source | | |
|--------------------------------|--|---|--|--|
| Humidity Test | $+40^{\circ}$ C ± 2° C, humidity of 90% ± 5% (total 96 hours). | MIL-STD-202G Method 103B Test Condition B | | |
| High Temperature Test | 1.Temperature: +125°C±2°C 2.Test time: 48±2hrs | IEC 68-2 Test Condition B | | |
| Low Temperature Test | 1.Temperature: -40°C ±2°C 2.Test time: 48±2hrs | IEC 68-2 Test Condition A | | |
| Thermal Shock | +125°C±5°C (30 minutes) ~ -40 ± 5°C (30 minutes), temperature switch time: 5 minutes (total 50 cycles). | MIL-STD-202G Method 107G Test Condition B-2 | | |
| Life Test | +70°C±5°C (250Hours) | MIL-STD-202G Method 108A Test Condition B | | |
| Vibration Test | 10-55-10HZ, amplitude: 1.5mm, direction: X, Y, Z axes, each axis 2 hours (total 6 hours). | MIL-STD-202G Method 201A | | |
| Solder Heat Resistance Test | IR/convection reflow:Peak Temp 260±5°C for 30Sec in air, Through 2 Cycle. Temperature Ramp:+1~4℃/sec; Abov e 217℃, must keep 90 s - 120 s. | J-STD-020D Classification Reflow Profiles | | |
| Solder Ability Test | Soak in 245 ℃ solder pot of 3Sec, PAD must have 95% above coverage. | J-STD-003B | | |

Typical RoHS Reflow Profile

Typical RoHS Reflow Profile 300 Time within 5°C of peak temperature (30 seconds) 250 Peak temperature 255 – 260°C Ramp-Up 3°C/sec max Ramp-Down 217 200 Temperature (°C) 150 Preheat/Soak Reflow 100 Time above 217°C (60-120 seconds) (60 - 150 seconds) 50 30 60 150 180 210 300 90 120 240 270 Time (seconds)



Packaging



¾ 10 sprocket hole pitch cumulative tolerance ±0.20

UNIT: mm

| | Α | В | С | Е | N | Р | W | t | A0 | В0 | K0 |
|------|------|------|------|------|-----|------|------|-------|------|------|------|
| DIM. | 330 | 20.0 | 13.0 | 25.0 | 100 | 16.0 | 24.0 | 0.4 | 13.1 | 14.9 | 6.7 |
| TOL. | ±0.2 | ±0.5 | ±0.5 | ±0.5 | MIN | ±0.1 | ±0.3 | ±0.05 | ±0.1 | ±0.1 | ±0.1 |

Quantity per reel: 500 pcs

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